AMENDMENT TRANSMITTAL LETTER (Large Entity) Applicant(s): Ling CHEN et al.						Docket No. AM-5209.D2		
Serial No. 10/693,775		Filing Date October 24, 2003		Examiner unknown			Group Art Unit 2813	
Invention Fam.	- E	rier Layer for	Copper Metalliza	tion				
Contract weeks		TC	THE COMMISSI	ONER FOR PATENTS:				
Transmitted here	with is an	amendment ir	n the above-identi	fied application.				
The fee has been	calculate	d and is trans	mitted as shown b	pelow.				
CLAIMS AS AMENDED								
	CLAIMS REMAINING		HIGHEST#	NUMBER EXTRA	RATE		ADDITIONAL	
	 	MENDMENT	PREV. PAID FOR			0.00	FEE	
TOTAL CLAIMS	41	•	16 =		 	8.00	\$450.00 \$430.00	
INDEP. CLAIMS 8 -		3 =	5	x \$8	6.00	\$0.00		
intended of operation of content of the content of							\$880.00	
 No additional fee is required for amendment. □ Please charge Deposit Account No. in the amount of ☒ A check in the amount of \$880.00 to cover the filing fee is enclosed. ☒ The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 50-0636 ☒ Any additional filing fees required under 37 C.F.R. 1.16. ☒ Any patent application processing fees under 37 CFR 1.17. Charles S. Guenzer, Reg. No. 30,640								
(650) 566-8040 Mailing Address: Applied Material Patent/Legal Dep P.O. Box 450A Santa Clara, CA			April 6, 2004 class mail under for Patents, P.O. Box	I certify that this document and fee is being deposited on April 6, 2004 with the U.S. Postal Service as first class mail under 37C.F.R. 1.8 and is addressed to the for Patents, P.O. Box 1450, ALexandria, VA 22313-1450. Signature of Person Mailing Correspondence Ingrid C. Mallory				

Typed or Printed Name of Person Mailing Correspondence

Docket: AM-5209.D2

Introductory Comments

FICATE OF MAILING

I hereby certify that this correspondence is, on the date below, being deposited with the U.S. Postal Service as first-class mail in an envelope addressed to the

Commissioner for Patents, Alexandria, VA 22313-1450.

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Ling CHEN et al.

Attorneys Docket:

AM-5209.D2

Serial No.:

10/693,775

Art Unit No .:

2813

Filed:

October 24, 2003

Examiner:

unknown

"TANTALUM BARRIER LAYER FOR COPPER METALLIZATION"

Commissioner for Patents Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT UNDER 37 CFR §1.115

Sir:

In Preliminary Amendment for entry before initial examination, please amend the above application as follows: